



Lyontek Inc.

LY61L2568A

Rev. 1.0

256K X 8 BIT HIGH SPEED CMOS SRAM

REVISION HISTORY

Revision

Rev. 1.0

Description

Initial Issue

Issue Date

Dec. 20. 2012

FEATURES

- Fast access time : 8/10/12ns
- **Low power consumption:**
Operating current:
50/40/35mA(TYP.)
Standby current:
2mA(TYP.)
- Single 3.3V power supply
- All inputs and outputs TTL compatible
- Fully static operation
- Tri-state output
- Data retention voltage : 1.5V (MIN.)
- Green package available
- Package : 44-pin 400 mil TSOP-II

GENERAL DESCRIPTION

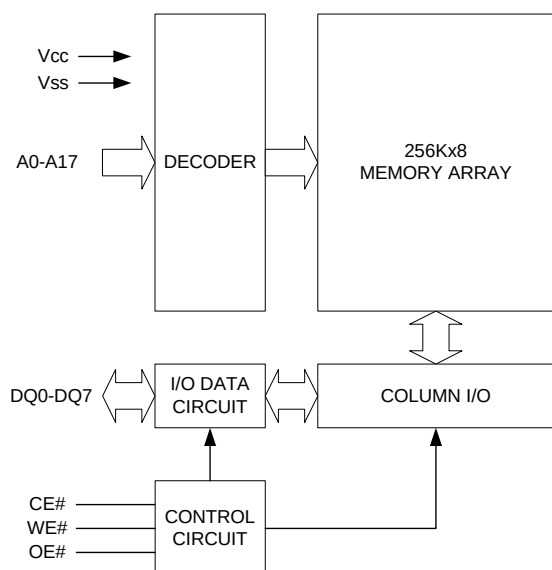
The LY61L2568A is a 2,097,152-bit high speed CMOS static random access memory organized as 262144 words by 8 bits. It is fabricated using very high performance, high reliability CMOS technology. Its standby current is stable within the range of operating temperature.

The LY61L2568A operates from a single power supply of 3.3V and all inputs and outputs are fully TTL compatible

PRODUCT FAMILY

Product Family	Operating Temperature	Vcc Range	Speed	Power Dissipation	
				Standby(I _{SB1} ,TYP.)	Operating(I _{CC1} ,TYP.)
LY61L2568A	0 ~ 70°C	2.7 ~ 3.6V	10/12ns	2mA	40/35mA
		3.0 ~ 3.6V	8ns	2mA	50mA
LY61L2568A(I)	-40 ~ 85°C	2.7 ~ 3.6V	10/12ns	2mA	40/35mA
		3.0 ~ 3.6V	8ns	2mA	50mA

FUNCTIONAL BLOCK DIAGRAM

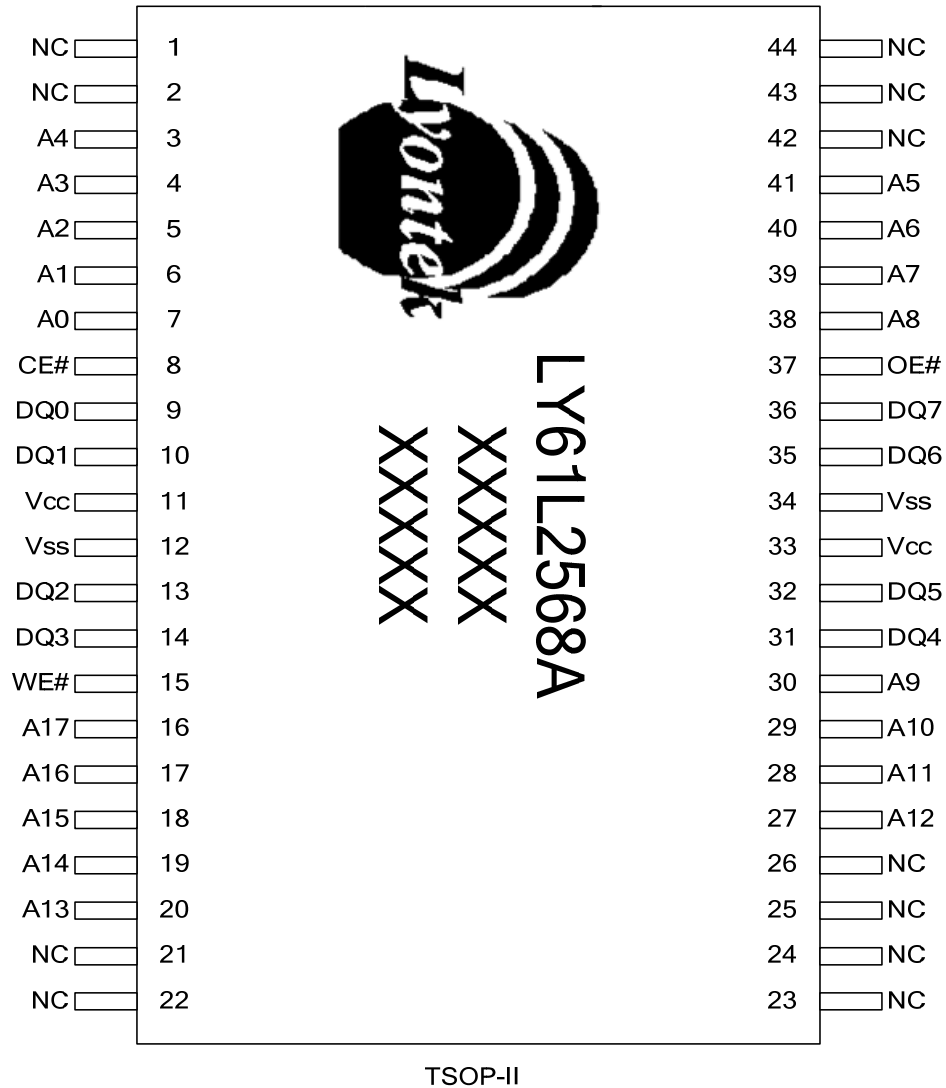


PIN DESCRIPTION

SYMBOL	DESCRIPTION
A0 - A17	Address Inputs
DQ0 – DQ7	Data Inputs/Outputs
CE#	Chip Enable Inputs
WE#	Write Enable Input
OE#	Output Enable Input
Vcc	Power Supply
Vss	Ground
NC	No Connection



PIN CONFIGURATION





ABSOLUTE MAXIMUM RATINGS*

PARAMETER	SYMBOL	RATING	UNIT
Voltage on V _{CC} relative to V _{SS}	V _{T1}	-0.5 to 4.6	V
Voltage on any other pin relative to V _{SS}	V _{T2}	-0.5 to V _{CC} +0.5	V
Operating Temperature	T _A	0 to 70(C grade) -40 to 85(I grade)	°C
Storage Temperature	T _{STG}	-65 to 150	°C
Power Dissipation	P _D	1	W
DC Output Current	I _{OUT}	50	mA

*Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to the absolute maximum rating conditions for extended period may affect device reliability.

TRUTH TABLE

MODE	CE#	OE#	WE#	I/O OPERATION	SUPPLY CURRENT
Standby	H	X	X	High-Z	I _{SB} , I _{SB1}
Output Disable	L	H	H	High-Z	I _{CC} , I _{CC1}
Read	L	L	H	D _{OUT}	I _{CC} , I _{CC1}
Write	L	X	L	D _{IN}	I _{CC} , I _{CC1}

Note: H = V_{IH}, L = V_{IL}, X = Don't care

DC ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP. ^{*4}	MAX.	UNIT
Supply Voltage	V _{CC}		-8 -10/-12	3.0 2.7	3.3 3.3	3.6 3.6 V
Input High Voltage	V _{IH} ^{*1}		2.2	-	V _{CC} +0.3	V
Input Low Voltage	V _{IL} ^{*2}		- 0.3	-	0.8	V
Input Leakage Current	I _{LI}	V _{CC} ≥ V _{IN} ≥ V _{SS}	- 1	-	1	μA
Output Leakage Current	I _{LO}	V _{CC} ≥ V _{OUT} ≥ V _{SS} , Output Disabled	- 1	-	1	μA
Output High Voltage	V _{OH}	I _{OH} = -8mA	2.4	-	-	V
Output Low Voltage	V _{OL}	I _{OL} = 4mA	-	-	0.4	V
Average Operating Power supply Current	I _{CC}	Cycle time = Min. CE# = V _{IL} , I _{I/O} = 0mA, Others at V _{IL} or V _{IH}	-8 -10 -12	- - -	65 50 45	80 70 60 mA
Average Operating Power supply Current	I _{CC1}	CE# ≤ 0.2, Others at 0.2V or V _{CC} -0.2V I _{I/O} = 0mA; f = max	-8 -10 -12	- - -	50 40 35	60 55 50 mA
Standby Power Supply Current	I _{SB}	CE# = V _{IH} , Others at V _{IL} or V _{IH}	-	-	30	mA
	I _{SB1}	CE# ≥ V _{CC} - 0.2V, Others at 0.2V or V _{CC} - 0.2V	-	2	10	mA

Notes:

- V_{IH}(max) = V_{CC} + 2.0V for pulse width less than 6ns.
 - V_{IL}(min) = V_{SS} - 2.0V for pulse width less than 6ns.
 - Over/Undershoot specifications are characterized on engineering evaluation stage, not for mass production test.
 - Typical values are included for reference only and are not guaranteed or tested.
- Typical values are measured at V_{CC} = V_{CC}(TYP.) and T_A = 25°C



CAPACITANCE ($T_A = 25^\circ\text{C}$, $f = 1.0\text{MHz}$)

PARAMETER	SYMBOL	MIN.	MAX	UNIT
Input Capacitance	C_{IN}	-	8	pF
Input/Output Capacitance	$C_{I/O}$	-	10	pF

Note : These parameters are guaranteed by device characterization, but not production tested.

AC TEST CONDITIONS

Speed	8/10/12ns
Input Pulse Levels	0.2V to $V_{CC} - 0.2V$
Input Rise and Fall Times	3ns
Input and Output Timing Reference Levels	1.5V
Output Load	$C_L = 30\text{pF} + 1\text{TTL}$, $I_{OH}/I_{OL} = -4\text{mA}/8\text{mA}$

AC ELECTRICAL CHARACTERISTICS

(1) READ CYCLE

PARAMETER	SYM.	LY61L2568A-8		LY61L2568A-10		LY61L2568A-12		UNIT
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
Read Cycle Time	t_{RC}	8	-	10	-	12	-	ns
Address Access Time	t_{AA}	-	8	-	10	-	12	ns
Chip Enable Access Time	t_{ACE}	-	8	-	10	-	12	ns
Output Enable Access Time	t_{OE}	-	4.5	-	4.5	-	5	ns
Chip Enable to Output in Low-Z	t_{CLZ}^*	2	-	2	-	3	-	ns
Output Enable to Output in Low-Z	t_{OLZ}^*	0	-	0	-	0	-	ns
Chip Disable to Output in High-Z	t_{CHZ}^*	-	3	-	4	-	5	ns
Output Disable to Output in High-Z	t_{OHZ}^*	-	3	-	4	-	5	ns
Output Hold from Address Change	t_{OH}	2	-	2	-	2	-	ns

(2) WRITE CYCLE

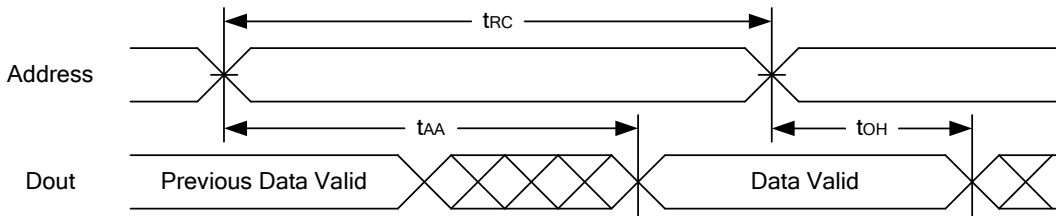
PARAMETER	SYM.	LY61L2568A-8		LY61L2568A-10		LY61L2568A-12		UNIT
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
Write Cycle Time	t_{WC}	8	-	10	-	12	-	ns
Address Valid to End of Write	t_{AW}	6.5	-	8	-	10	-	ns
Chip Enable to End of Write	t_{CW}	6.5	-	8	-	10	-	ns
Address Set-up Time	t_{AS}	0	-	0	-	0	-	ns
Write Pulse Width	t_{WP}	6.5	-	8	-	10	-	ns
Write Recovery Time	t_{WR}	0	-	0	-	0	-	ns
Data to Write Time Overlap	t_{DW}	5	-	6	-	7	-	ns
Data Hold from End of Write Time	t_{DH}	0	-	0	-	0	-	ns
Output Active from End of Write	t_{OW}^*	2	-	2	-	2	-	ns
Write to Output in High-Z	t_{WHZ}^*	-	3	-	4	-	5	ns

*These parameters are guaranteed by device characterization, but not production tested.

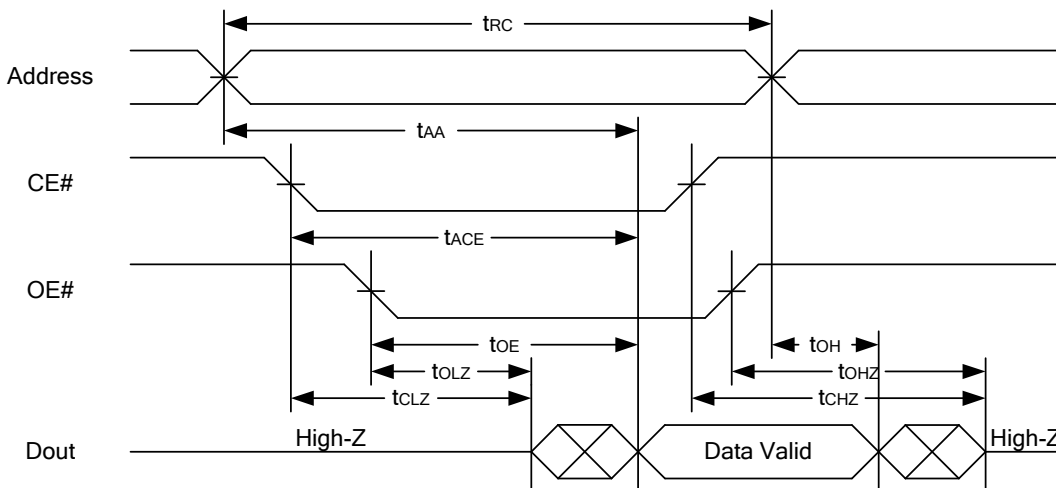


TIMING WAVEFORMS

READ CYCLE 1 (Address Controlled) (1,2)



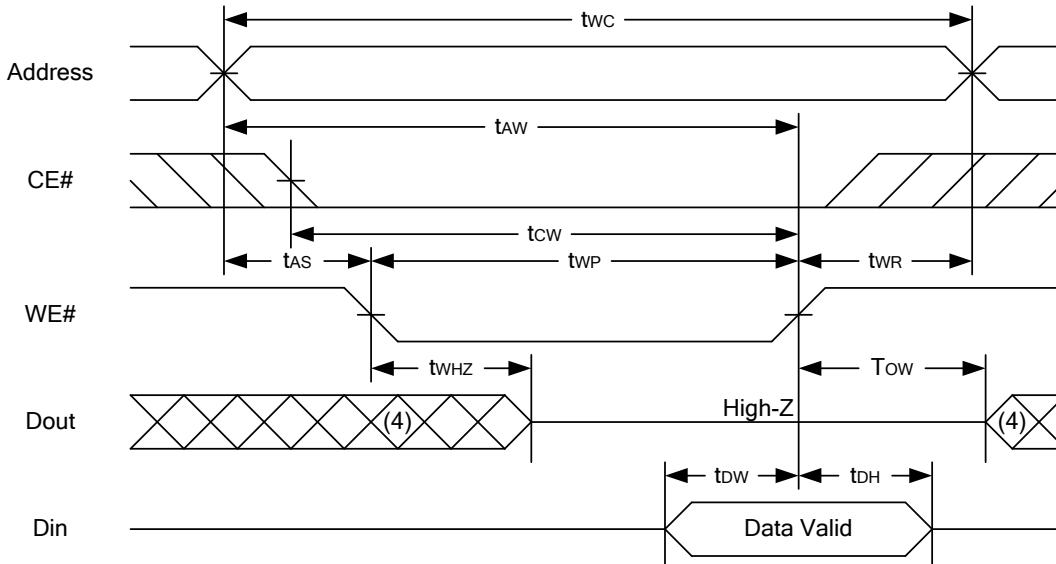
READ CYCLE 2 (CE# and OE# Controlled) (1,3,4,5)



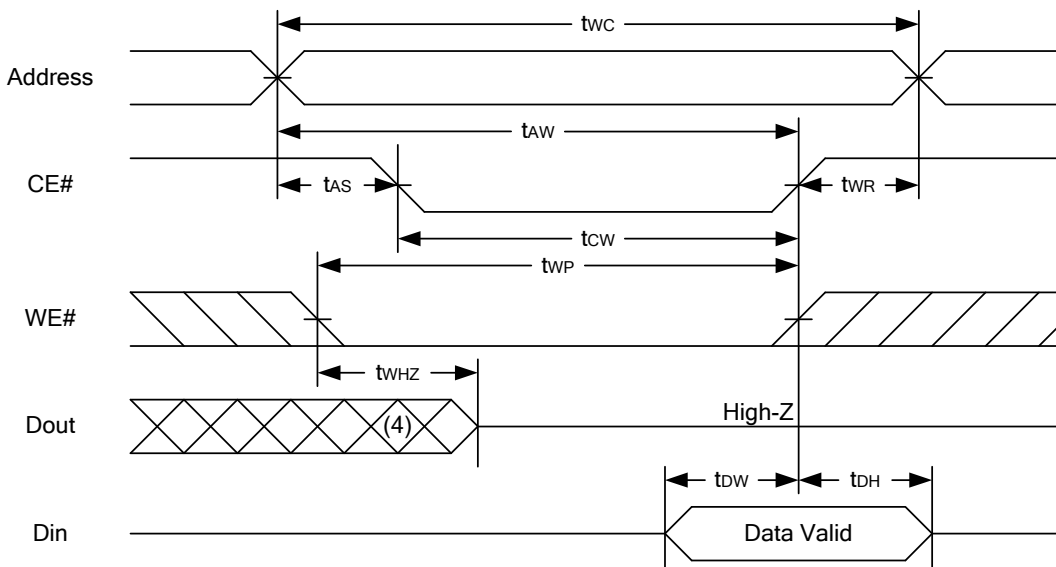
Notes :

1. WE# is high for read cycle.
2. Device is continuously selected OE# = low, CE# = low.
3. Address must be valid prior to or coincident with CE# = low,; otherwise t_{AA} is the limiting parameter.
4. t_{CLZ} , t_{OLZ} , t_{CHZ} and t_{OHZ} are specified with $C_L = 5\text{pF}$. Transition is measured $\pm 500\text{mV}$ from steady state.
5. At any given temperature and voltage condition, t_{CHZ} is less than t_{CLZ} , t_{OHZ} is less than t_{OLZ} .

WRITE CYCLE 1 (WE# Controlled) (1,2,3,5,6)



WRITE CYCLE 2 (CE# Controlled) (1,2,5,6)



Notes :

1. WE#, CE# must be high during all address transitions.
2. A write occurs during the overlap of a low CE#, low WE#.
3. During a WE# controlled write cycle with OE# low, twp must be greater than twhZ + tDw to allow the drivers to turn off and data to be placed on the bus.
4. During this period, I/O pins are in the output state, and input signals must not be applied.
5. If the CE# low transition occurs simultaneously with or after WE# low transition, the outputs remain in a high impedance state.
6. tow and twhZ are specified with CL = 5pF. Transition is measured $\pm 500\text{mV}$ from steady state.

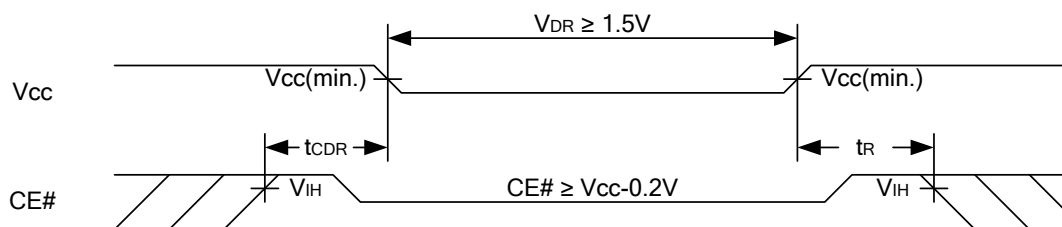


DATA RETENTION CHARACTERISTICS

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
V _{CC} for Data Retention	V _{DR}	CE# $\geq$ V _{CC} - 0.2V	1.5	-	3.6	V
Data Retention Current	I _{DR}	V _{CC} = 1.5V CE# $\geq$ V _{CC} - 0.2V Others at 0.2V or V _{CC} - 0.2V	-	2	10	mA
Chip Disable to Data Retention Time	t _{CDR}	See Data Retention Waveforms (below)	0	-	-	ns
Recovery Time	t _R		t _{RC} *	-	-	ns

t_{RC}* = Read Cycle Time

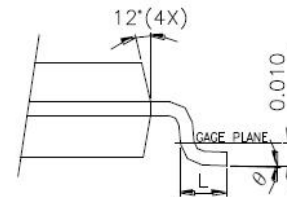
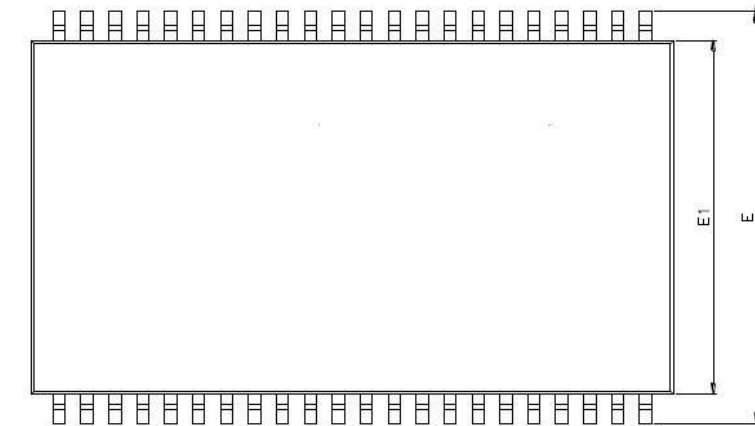
DATA RETENTION WAVEFORM



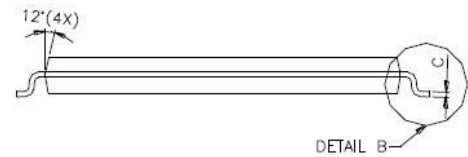
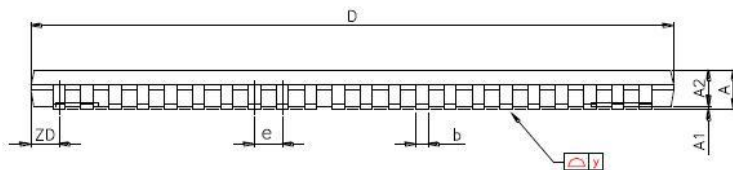


PACKAGE OUTLINE DIMENSION

44-pin 400mil TSOP- II Package Outline Dimension



DETAIL B



DETAIL B

SYMBOLS	DIMENSIONS IN MILLMETERS			DIMENSIONS IN MILS		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	-	-	1.20	-	-	47.2
A1	0.05	0.10	0.15	2.0	3.9	5.9
A2	0.95	1.00	1.05	37.4	39.4	41.3
b	0.30	-	0.45	11.8	-	17.7
c	0.12	-	0.21	4.7	-	8.3
D	18.212	18.415	18.618	717	725	733
E	11.506	11.760	12.014	453	463	473
E1	9.957	10.160	10.363	392	400	408
e	-	0.800	-	-	31.5	-
L	0.40	0.50	0.60	15.7	19.7	23.6
ZD	-	0.805	-	-	31.7	-
y	-	-	0.076	-	-	3
θ	0°	3°	6°	0°	3°	6°



Lyontek Inc.

LY61L2568A

Rev. 1.0

256K X 8 BIT HIGH SPEED CMOS SRAM

ORDERING INFORMATION

Package Type	Access Time (Speed)(ns)	Temperature Range(°C)	Packing Type	Lyontek Item No.
44Pin(400mil) TSOP-II	8	0°C~70°C	Tray	LY61L2568AML-8
			Tape Reel	LY61L2568AML-8T
		-40°C~85°C	Tray	LY61L2568AML-8I
			Tape Reel	LY61L2568AML-8IT
	10	0°C~70°C	Tray	LY61L2568AML-10
			Tape Reel	LY61L2568AML-10T
		-40°C~85°C	Tray	LY61L2568AML-10I
			Tape Reel	LY61L2568AML-10IT



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